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74LVC139

Dual 2-to-4 line decoder/demultiplexer

Rev. 5 — 19 October 2011

Product data sheet

1. General description

The 74LVC139 is a dual 2-to-4 line decoder/demultiplexer. It has two independent decoders, each accepting two binary weighted inputs (nA0 and nA1) and providing four mutually exclusive outputs ($\overline{nY0}$ to $\overline{nY3}$) that are LOW when selected. Each decoder has an active LOW input (\overline{nE}). When \overline{nE} is HIGH, every output is forced HIGH. The enable input can be used as the data input for a 1-to-4 demultiplexer application.

2. Features and benefits

- Wide supply voltage range from 1.2 V to 3.6 V
- Inputs accept voltages up to 5.5 V
- CMOS low power consumption
- Direct interface with TTL levels
- Demultiplexing capability
- Two independent 2-to-4 decoders
- Multifunction capability
- Mutually exclusive outputs
- Output drive capability 50 Ω transmission lines at 125 °C
- Complies with JEDEC standard:
 - ◆ JESD8-7A (1.65 V to 1.95 V)
 - ◆ JESD8-5A (2.3 V to 2.7 V)
 - ◆ JESD8-C/JESD36 (2.7 V to 3.6 V)
- ESD protection:
 - HBM JESD22-A114F exceeds 2000 V
 - ♦ MM JESD22-A115-B exceeds 200 V
 - CDM JESD22-C101E exceeds 1000 V
- Specified from −40 °C to +85 °C and from −40 °C to +125 °C



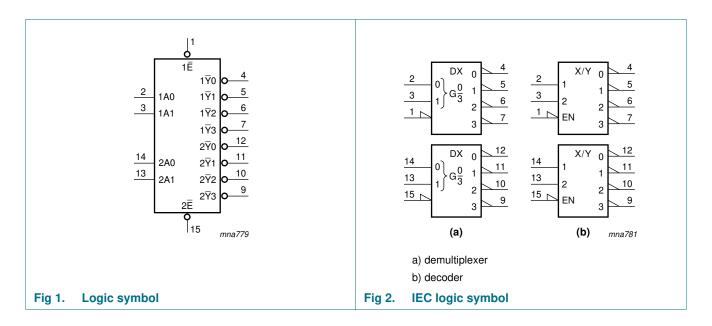
Dual 2-to-4 line decoder/demultiplexer

3. Ordering information

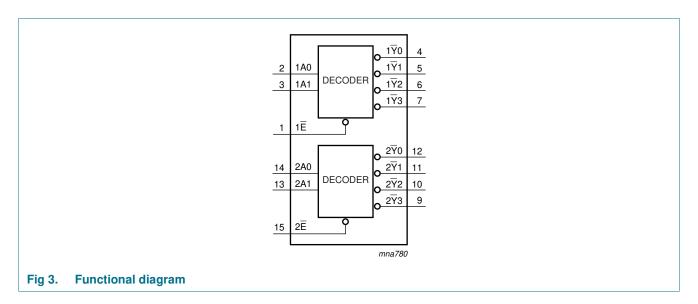
Table 1. Ordering information

| Type number | Package | | | |
|-------------|-------------------|----------|--|----------|
| | Temperature range | Name | Description | Version |
| 74LVC139D | –40 °C to +125 °C | SO16 | plastic small outline package; 16 leads; body width 3.9 mm | SOT109-1 |
| 74LVC139DB | –40 °C to +125 °C | SSOP16 | plastic shrink small outline package; 16 leads; body width 5.3 mm | SOT338-1 |
| 74LVC139PW | –40 °C to +125 °C | TSSOP16 | plastic thin shrink small outline package; 16 leads; body width 4.4 mm | SOT403-1 |
| 74LVC139BQ | –40 °C to +125 °C | DHVQFN16 | plastic dual in-line compatible thermal enhanced very thin quad flat package; no leads; 16 terminals; body $2.5\times3.5\times0.85$ mm | SOT763-1 |

4. Functional diagram

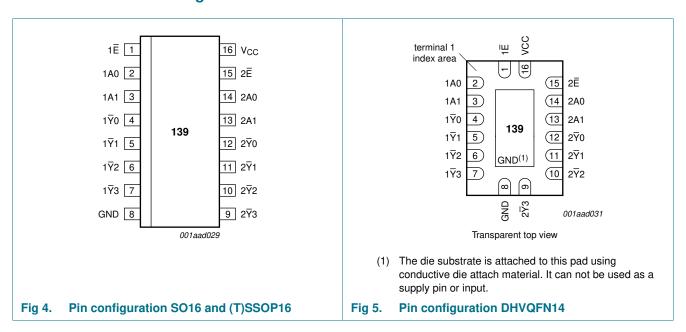


Dual 2-to-4 line decoder/demultiplexer



5. Pinning information

5.1 Pinning



5.2 Pin description

Table 2. Pin description

| 141010 21 1 11 | . accomplian | | |
|----------------------|--------------|--|---------------------------------------|
| Name | Pin | Description | |
| 1Ē | 1 | enable input (active LOW) | |
| 2E | 15 | enable input (active LOW) | |
| 1A[0:1] | 2, 3 | address input | |
| 2A[0:1] | 14, 13 | address input | |
| 1 Y [0:3] | 4, 5, 6, 7 | output | |
| 74LVC139 | Al | I information provided in this document is subject to legal disclaimers. | © NXP B.V. 2011. All rights reserved. |

Dual 2-to-4 line decoder/demultiplexer

Table 2. Pin description ... continued

| Name | Pin | Description |
|----------------------|---------------|-------------------------|
| 2 Y [0:3] | 12, 11, 10, 9 | output |
| GND | 8 | ground (0 V) |
| V _{CC} | 16 | positive supply voltage |

6. Functional description

Table 3. Function table[1]

| Input | | | Output | Output | | | | | | | |
|-------|-----|---------|--------|--------|-----|-----|--|--|--|--|--|
| nE | nA0 | nA0 nA1 | | nY1 | nY2 | nY3 | | | | | |
| Н | X | X | Н | Н | Н | Н | | | | | |
| L | L | L | L | Н | Н | Н | | | | | |
| L | Н | L | Н | L | Н | Н | | | | | |
| L | L | Н | Н | Н | L | Н | | | | | |
| L | Н | Н | Н | Н | Н | L | | | | | |

^[1] H = HIGH voltage level; L = LOW voltage level; X = don't care

7. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

| Symbol | Parameter | Conditions | Min | Max | Unit |
|------------------|-------------------------|--|-----------------|----------------|------|
| V_{CC} | supply voltage | | -0.5 | +6.5 | V |
| I _{IK} | input clamping current | V ₁ < 0 | -50 | - | mA |
| V_{I} | input voltage | | <u>[1]</u> –0.5 | +6.5 | V |
| I _{OK} | output clamping current | $V_O > V_{CC}$ or $V_O < 0$ V | - | ±50 | mA |
| V_{O} | output voltage | | <u>[2]</u> –0.5 | $V_{CC} + 0.5$ | V |
| Io | output current | $V_O = 0 V \text{ to } V_{CC}$ | - | ±50 | mA |
| I _{CC} | supply current | | - | 100 | mA |
| I_{GND} | ground current | | -100 | - | mA |
| T _{stg} | storage temperature | | -65 | +150 | °C |
| P _{tot} | total power dissipation | $T_{amb} = -40 ^{\circ}\text{C} \text{ to } +125 ^{\circ}\text{C}$ | [3] _ | 500 | mW |

^[1] The minimum input voltage ratings may be exceeded if the input current ratings are observed.

^[2] The output voltage ratings may be exceeded if the output current ratings are observed.

^[3] For SO16 packages: above 70 °C derate linearly with 8 mW/K.
For SSOP16 and TSSOP16 packages: above 60 °C derate linearly with 5.5 mW/K.
For DHVQFN16 packages: above 60 °C derate linearly with 4.5 mW/K.

Dual 2-to-4 line decoder/demultiplexer

8. Recommended operating conditions

Table 5. Recommended operating conditions

| Symbol | Parameter | Conditions | Min | Тур | Max | Unit |
|---------------------|--------------------------------|---|------|-----|----------|------|
| V_{CC} | supply voltage | | 1.65 | - | 3.6 | V |
| | | functional | 1.2 | - | - | V |
| V _I | input voltage | | 0 | - | 5.5 | V |
| V _O | output voltage | | 0 | - | V_{CC} | V |
| T _{amb} | ambient temperature | in free air | -40 | | +125 | °C |
| $\Delta t/\Delta V$ | input transition rise and fall | $V_{CC} = 1.65 \text{ V to } 2.7 \text{ V}$ | 0 | - | 20 | ns/V |
| | rate | V _{CC} = 2.7 V to 3.6 V | 0 | - | 10 | ns/V |

9. Static characteristics

Table 6. Static characteristics

At recommended operating conditions. Voltages are referenced to GND (ground = 0 V).

| Symbol | Parameter | Conditions | _40 | °C to +8 | 85 °C | –40 °C to | Unit | |
|-----------------|--------------------------|--|------------------------|----------|----------------------|------------------------|----------------------|----|
| Cymbol | T didilictor | Conditions | Min | Typ[1] | | Min | Max | 0 |
| V _{IH} | HIGH-level | V _{CC} = 1.2 V | 1.08 | - | - | 1.08 | - | V |
| | input voltage | V _{CC} = 1.65 V to 1.95 V | 0.65 × V _{CC} | - | - | 0.65 × V _{CC} | - | ٧ |
| | | V _{CC} = 2.3 V to 2.7 V | 1.7 | - | - | 1.7 | - | ٧ |
| | | $V_{CC} = 2.7 \text{ V to } 3.6 \text{ V}$ | 2.0 | - | - | 2.0 | - | ٧ |
| V _{IL} | LOW-level | V _{CC} = 1.2 V | - | - | 0.12 | - | 0.12 | ٧ |
| | input voltage | V _{CC} = 1.65 V to 1.95 V | - | - | $0.35 \times V_{CC}$ | - | $0.35 \times V_{CC}$ | ٧ |
| | | $V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$ | - | - | 0.7 | - | 0.7 | ٧ |
| | | V _{CC} = 2.7 V to 3.6 V | - | - | 0.8 | - | 0.8 | ٧ |
| V_{OH} | HIGH-level | $V_I = V_{IH}$ or V_{IL} | | | | | | |
| | output voltage | $I_O = -100 \mu A;$ $V_{CC} = 1.65 \text{ V to } 3.6 \text{ V}$ | $V_{\text{CC}}-0.2$ | - | - | $V_{CC}-0.3$ | - | V |
| | | $I_{O} = -4 \text{ mA}; V_{CC} = 1.65 \text{ V}$ | 1.2 | - | - | 1.05 | - | ٧ |
| | | $I_{O} = -8 \text{ mA}; V_{CC} = 2.3 \text{ V}$ | 1.8 | - | - | 1.65 | - | ٧ |
| | | $I_{O} = -12 \text{ mA}; V_{CC} = 2.7 \text{ V}$ | 2.2 | - | - | 2.05 | - | V |
| | | $I_{O} = -18 \text{ mA}; V_{CC} = 3.0 \text{ V}$ | 2.4 | - | - | 2.25 | - | ٧ |
| | | $I_{O} = -24 \text{ mA}; V_{CC} = 3.0 \text{ V}$ | 2.2 | - | - | 2.0 | - | ٧ |
| V_{OL} | LOW-level | $V_I = V_{IH}$ or V_{IL} | | | | | | |
| | output voltage | $I_O = 100 \mu A;$ $V_{CC} = 1.65 \text{ V to } 3.6 \text{ V}$ | - | - | 0.2 | - | 0.3 | V |
| | | $I_O = 4 \text{ mA}; V_{CC} = 1.65 \text{ V}$ | - | - | 0.45 | - | 0.65 | V |
| | | $I_{O} = 8 \text{ mA}; V_{CC} = 2.3 \text{ V}$ | - | - | 0.6 | - | 0.8 | ٧ |
| | | $I_O = 12 \text{ mA}; V_{CC} = 2.7 \text{ V}$ | - | - | 0.4 | - | 0.6 | V |
| | | $I_O = 24 \text{ mA}; V_{CC} = 3.0 \text{ V}$ | - | - | 0.55 | - | 8.0 | V |
| I _I | input leakage current | $V_{CC} = 3.6 \text{ V}; V_I = 5.5 \text{ V or GND}$ | - | ±0.1 | ±5 | - | ±20 | μА |

Dual 2-to-4 line decoder/demultiplexer

Table 6. Static characteristics ... continued

At recommended operating conditions. Voltages are referenced to GND (ground = 0 V).

| Symbol | Parameter | Conditions | -40 | °C to +8 | 85 °C | -40 °C to | +125 °C | Unit |
|-----------------|---------------------------------|--|-----|----------|-------|-----------|---------|------|
| | | | Min | Typ[1] | Max | Min | Max | |
| I _{CC} | supply current | $V_{CC} = 3.6 \text{ V}; V_I = V_{CC} \text{ or GND};$ $I_O = 0 \text{ A}$ | - | 0.1 | 10 | - | 40 | μΑ |
| ΔI_{CC} | additional supply current | per input pin ; $V_{CC} = 2.7 \text{ V to } 3.6 \text{ V;}$ $V_{I} = V_{CC} - 0.6 \text{ V; } I_{O} = 0 \text{ A}$ | - | 5 | 500 | - | 5000 | μΑ |
| Cı | input capacitance | $V_{CC} = 0 \text{ V to } 3.6 \text{ V};$ $V_{I} = \text{GND to } V_{CC}$ | - | 5.0 | - | - | - | pF |

^[1] All typical values are measured at V_{CC} = 3.3 V (unless stated otherwise) and T_{amb} = 25 °C.

10. Dynamic characteristics

Table 7. Dynamic characteristics

Voltages are referenced to GND (ground = 0 V). For test circuit see Figure 8.

| Symbol | Parameter | Conditions | | -40 | °C to +8 | 5 °C | -40 °C to | +125 °C | Unit |
|--------------------|-------------------|---|------------|-----|----------|------|-----------|---------|------|
| | | | Ī | Min | Typ[1] | Max | Min | Max | |
| t _{pd} | propagation delay | nAn to \overline{Y} n; see $\underline{Figure 6}$ | [2] | | ' | | | ' | |
| | | V _{CC} = 1.2 V | | - | 14 | - | - | - | ns |
| | | $V_{CC} = 1.65 \text{ V to } 1.95 \text{ V}$ | | 0.5 | 4.7 | 10.4 | 0.5 | 11.3 | ns |
| | | $V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$ | | 1.0 | 2.8 | 5.9 | 1.0 | 6.5 | ns |
| | | $V_{CC} = 2.7 \text{ V}$ | | 1.0 | 3.0 | 6.3 | 1.0 | 8.0 | ns |
| | | $V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$ | | 1.0 | 2.5 | 5.3 | 1.0 | 7.0 | ns |
| | | $n\overline{E}$ to \overline{Y} n; see Figure 7 | [2] | | | | | | |
| | | V _{CC} = 1.2 V | | - | 14 | - | - | - | ns |
| | | $V_{CC} = 1.65 \text{ V to } 1.95 \text{ V}$ | | 1.5 | 4.5 | 9.8 | 1.5 | 10.7 | ns |
| | | $V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$ | | 2.1 | 2.7 | 5.6 | 2.1 | 6.1 | ns |
| | | $V_{CC} = 2.7 \text{ V}$ | | 1.0 | 2.8 | 5.4 | 1.0 | 7.0 | ns |
| | | $V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$ | | 1.0 | 2.4 | 5.0 | 1.0 | 6.5 | ns |
| t _{sk(o)} | output skew time | $V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$ | [3] | - | - | 1.0 | - | 1.5 | ns |
| C_{PD} | power dissipation | $V_I = GND$ to V_{CC} | <u>[4]</u> | | | | | | |
| capacitance | capacitance | $V_{CC} = 1.65 \text{ V to } 1.95 \text{ V}$ | | - | 5.6 | - | - | - | рF |
| | | $V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$ | | - | 11.3 | - | - | - | рF |
| | | $V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$ | | - | 16.4 | - | - | - | pF |

^[1] Typical values are measured at T_{amb} = 25 °C and V_{CC} = 1.2 V, 1.8 V, 2.5 V, 2.7 V, and 3.3 V respectively.

$$P_D = C_{PD} \times V_{CC}^2 \times f_i \times N + \sum (C_L \times V_{CC}^2 \times f_o)$$
 where:

 f_i = input frequency in MHz; f_o = output frequency in MHz

C_L = output load capacitance in pF

V_{CC} = supply voltage in V

N = number of inputs switching,

74LVC139

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^[2] t_{pd} is the same as t_{PLH} and t_{PHL} .

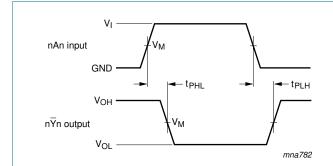
^[3] Skew between any two outputs of the same package switching in the same direction. This parameter is guaranteed by design.

^[4] C_{PD} is used to determine the dynamic power dissipation (P_D in μW).

Dual 2-to-4 line decoder/demultiplexer

 $\sum (C_L \times V_{CC}{}^2 \times f_o)$ = sum of outputs.

11. Waveforms

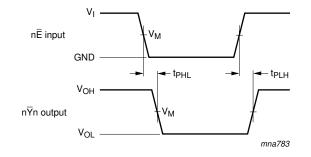


 V_M = 1.5 V at $V_{CC} \geq 2.7$ V.

 $V_M = 0.5 \times V_{CC}$ at $V_{CC} < 2.7$ V.

 V_{OL} and V_{OH} are the typical output voltage levels that occur with the output load.

Fig 6. Input (nAn) to output $(n\overline{Y}n)$ propagation delays



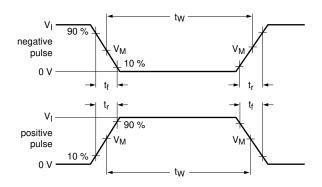
 $V_M=1.5\ V$ at $V_{CC}\geq 2.7\ V.$

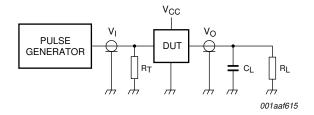
 $V_M = 0.5 \times V_{CC}$ at $V_{CC} < 2.7 \ V.$

 $V_{\mbox{\scriptsize OL}}$ and $V_{\mbox{\scriptsize OH}}$ are the typical output voltage levels that occur with the output load.

Fig 7. Enable input (nE) to output (nYn) propagation delays

Dual 2-to-4 line decoder/demultiplexer





Test data is given in Table 8.

Definitions for test circuit:

 R_L = Load resistance.

 C_L = Load capacitance including jig and probe capacitance.

 R_T = Termination resistance should be equal to output impedance Z_o of the pulse generator.

Fig 8. Load circuitry for switching times

Table 8. Test data

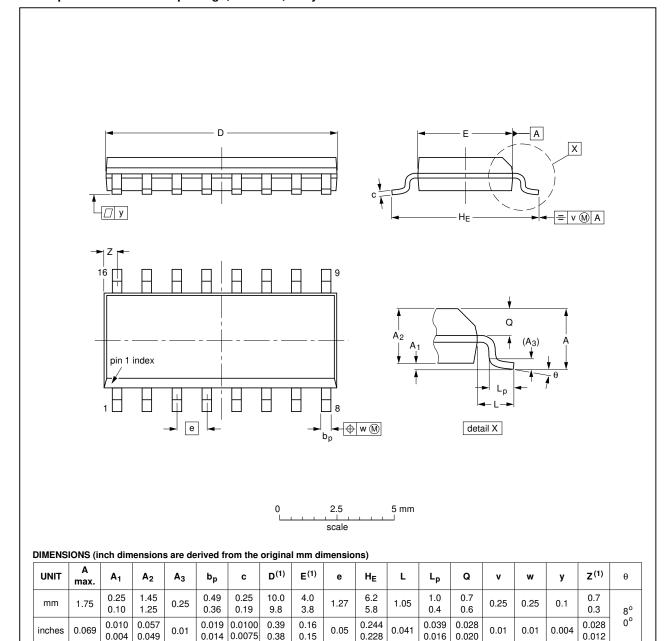
| Supply voltage | Input | | Load | Load | | | | |
|------------------|-----------------|---------------------------------|----------------|----------------|--|--|--|--|
| | V _I | t _r , t _f | C _L | R _L | | | | |
| 1.2 V | V _{CC} | ≤ 2 ns | 30 pF | 1 kΩ | | | | |
| 1.65 V to 1.95 V | V_{CC} | ≤ 2 ns | 30 pF | 1 kΩ | | | | |
| 2.3 V to 2.7 V | V_{CC} | ≤ 2 ns | 30 pF | 500 Ω | | | | |
| 2.7 V | 2.7 V | ≤ 2.5 ns | 50 pF | 500 Ω | | | | |
| 3.0 V to 3.6 V | 2.7 V | ≤ 2.5 ns | 50 pF | 500 Ω | | | | |

Dual 2-to-4 line decoder/demultiplexer

12. Package outline

SO16: plastic small outline package; 16 leads; body width 3.9 mm

SOT109-1



Note

1. Plastic or metal protrusions of 0.15 mm (0.006 inch) maximum per side are not included.

| OUTLINE | | REFER | EUROPEAN | ISSUE DATE | | |
|----------|--------|--------|----------|------------|------------|---------------------------------|
| VERSION | IEC | JEDEC | JEITA | | PROJECTION | ISSUE DATE |
| SOT109-1 | 076E07 | MS-012 | | | | 99-12-27 03-02-19 |

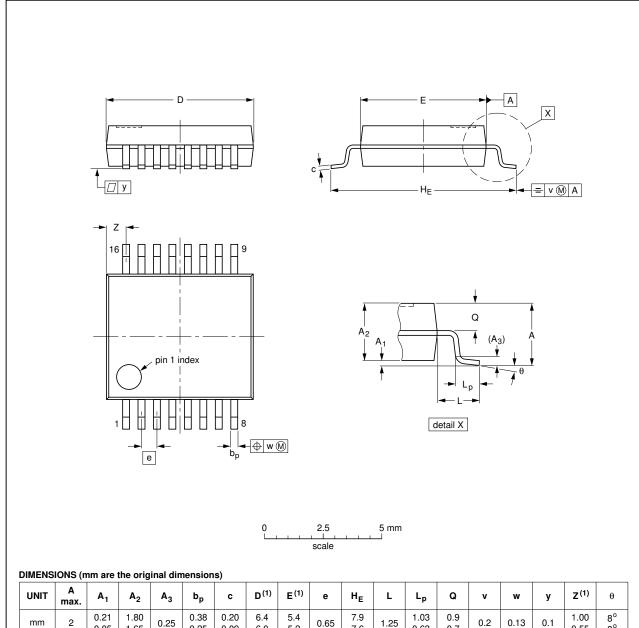
Fig 9. Package outline SOT109-1 (SO16)

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SSOP16: plastic shrink small outline package; 16 leads; body width 5.3 mm

SOT338-1



| - | | | | | | | | | | | | | | | | | | | |
|---|------|-----------|----------------|----------------|----------------|--------------|--------------|------------------|------------------|------|------------|------|--------------|------------|-----|------|-----|------------------|----------|
| | UNIT | A max. | A ₁ | A ₂ | A ₃ | bp | С | D ⁽¹⁾ | E ⁽¹⁾ | е | HE | L | Lp | Q | v | w | у | Z ⁽¹⁾ | θ |
| | mm | 2 | 0.21 0.05 | 1.80 1.65 | 0.25 | 0.38 0.25 | 0.20 0.09 | 6.4 6.0 | 5.4 5.2 | 0.65 | 7.9 7.6 | 1.25 | 1.03 0.63 | 0.9 0.7 | 0.2 | 0.13 | 0.1 | 1.00 0.55 | 8° 0° |

Note

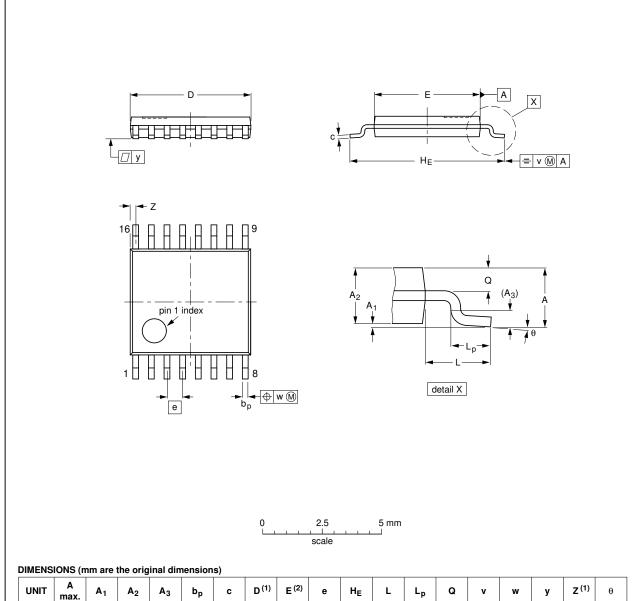
1. Plastic or metal protrusions of 0.25 mm maximum per side are not included.

| OUTLINE | | REFER | EUROPEAN | ISSUE DATE | | | |
|----------|-----------|--------|----------|------------|------------|---------------------------------|--|
| VERSION | IEC JEDEC | | JEITA | | PROJECTION | ISSUE DATE | |
| SOT338-1 | | MO-150 | | | | 99-12-27 03-02-19 | |

Fig 10. Package outline SOT338-1 (SSOP16)

TSSOP16: plastic thin shrink small outline package; 16 leads; body width 4.4 mm

SOT403-1



| UNIT | A max. | A ₁ | A ₂ | A ₃ | bp | С | D ⁽¹⁾ | E (2) | е | HE | L | Lp | Q | v | w | у | Z ⁽¹⁾ | θ |
|------|-----------|----------------|----------------|----------------|--------------|------------|------------------|------------|------|------------|---|--------------|------------|-----|------|-----|------------------|----------|
| mm | 1.1 | 0.15 0.05 | 0.95 0.80 | 0.25 | 0.30 0.19 | 0.2 0.1 | 5.1 4.9 | 4.5 4.3 | 0.65 | 6.6 6.2 | 1 | 0.75 0.50 | 0.4 0.3 | 0.2 | 0.13 | 0.1 | 0.40 0.06 | 8° 0° |

Notes

- 1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.
- 2. Plastic interlead protrusions of 0.25 mm maximum per side are not included.

| | | EUROPEAN | ISSUE DATE | | |
|-----|--------|----------|------------|------------|---------------------------------|
| IEC | JEDEC | JEITA | | PROJECTION | ISSUE DATE |
| | MO-153 | | | | 99-12-27 03-02-18 |
| _ | IEC | | | | IEC JEDEC JEHA |

Fig 11. Package outline SOT403-1 (TSSOP16)

74LVC13

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DHVQFN16: plastic dual in-line compatible thermal enhanced very thin quad flat package; no leads; 16 terminals; body 2.5 x 3.5 x 0.85 mm SOT763-1

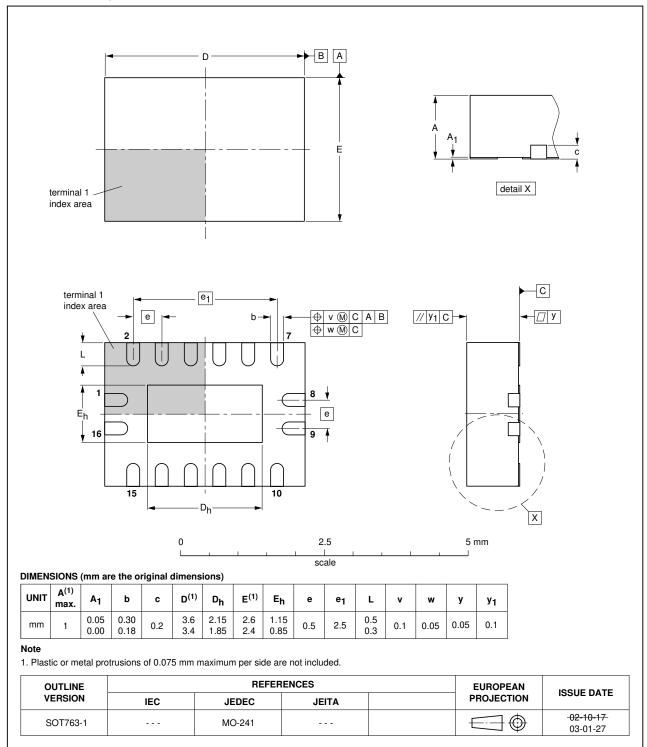


Fig 12. Package outline SOT763-1 (DHVQFN16)

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Dual 2-to-4 line decoder/demultiplexer

13. Abbreviations

Table 9. Abbreviations

| Acronym | Description |
|---------|-----------------------------|
| CDM | Charged Device Model |
| DUT | Device Under Test |
| ESD | ElectroStatic Discharge |
| НВМ | Human Body Model |
| MM | Machine Model |
| TTL | Transistor-Transistor Logic |

14. Revision history

Table 10. Revision history

| Document ID | Release date | Data sheet status | Change notice | Supersedes | | | | | |
|----------------|---|-------------------------------|--------------------------|----------------------|--|--|--|--|--|
| 74LVC139 v.5 | 20111019 | Product data sheet | - | 74LVC139 v.4 | | | | | |
| Modifications: | The format of this data sheet has been redesigned to comply with the new identity guidelines of NXP Semiconductors. | | | | | | | | |
| | Legal texts have been adapted to the new company name where appropriate. | | | | | | | | |
| | • Table 4, Table | 5, Table 6, Table 7 and Table | e 8: values added for lo | ower voltage ranges. | | | | | |
| 74LVC139 v.4 | 040315 | Product specification | - | 74LVC139 v.3 | | | | | |
| 74LVC139 v.3 | 030519 | Product specification | - | 74LVC139 v.2 | | | | | |
| 74LVC139 v.2 | 980428 | Product specification | - | 74LVC139 v.1 | | | | | |
| 74LVC139 v.1 | - | - | - | - | | | | | |
| | | | | | | | | | |

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15. Legal information

15.1 Data sheet status

| Document status[1][2] | Product status[3] | Definition |
|--------------------------------|-------------------|---|
| Objective [short] data sheet | Development | This document contains data from the objective specification for product development. |
| Preliminary [short] data sheet | Qualification | This document contains data from the preliminary specification. |
| Product [short] data sheet | Production | This document contains the product specification. |

- [1] Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions"
- [3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL http://www.nxp.com.

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